

July 2008 Power-SPMTM

FP7G100US60

Transfer Molded Type IGBT Module

General Description

Fairchild's New IGBT Modules (Transfer Molded Type) provide low conduction and switching losses as well as short circuit ruggedness. They are designed for applications such as Motor control, Uninterrupted Power Supplies (UPS) and general Inverters where short circuit ruggedness is a required feature.

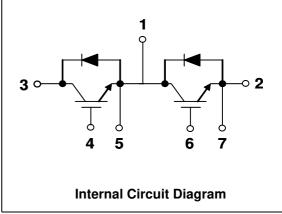
Features

- Short Circuit rated 10us @Tc=100°C, Vge=15V
- · High Speed Switching
- Low Saturation Voltage: Vce(sat) =2.2V @Ic=100A
- · High Input Impedance
- · Fast & Soft Anti-Parallel FWD

Application

- Welders
- · AC & DC Motor Controls
- · General Purpose Inverters
- Robotics
- · Servo Controls
- UPS





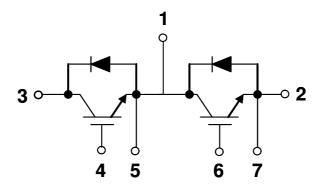
Absolute Maximum Ratings

Symbol	Description		Rating	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Collector Current	@ T _C = 25°C	100	Α
I _{CM (1)}	Pulsed Collector Current		200	Α
IF	Diode Continuous Forward Current	100	Α	
I _{FM}	Diode Maximum Forward Current		200	Α
T _{SC}	Short Circuit Withstand Time	@ T _C = 100°C	10	us
P _D	Maximum Power Dissipation	@ T _C = 25°C	400	W
T_J	Operating Junction Temperature		-40 to +125	°C
T _{stg}	Storage Temperature Range		-40 to +125	°C
V _{iso}	Isolation Voltage	@ AC 1minute	2500	V
Mounting	Power Terminals Screw : M5		2.0	N.m
Torque	Mounting Screw : M5		2.0	N.m

Pin Configuration and Pin Description



Top View



Internal Circuit Diagram

Pin Description

Pin Number	Pin Description		
1	Emitter of Q1, IGBT, Collector of Q2, IGBT		
2	Emitter of Q2, IGBT		
3	Collector of Q1, IGBT		
4	Gate of Q1, IGBT		
5	Emitter of Q1, IGBT		
6	Gate of Q2, IGBT		
7	Emitter of Q2, IGBT		

Electrical Characteristics (T_J = 25°C, Unless Otherwise Specified)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Off Char	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250\mu A$		-	-	V
ΔBV _{CES} / ΔΤ _J	Temperature Coeff. of Breakdown Voltage			0.6	-	V
I _{CES}	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	250	uA
I _{GES}	Gate-Emitter Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0V		-	± 100	nA
On Char	acteristics					
V _{GE(th)}	G-E Threshold Voltage	V _{GE} = 0V, I _C =100mA	5.0	6.0	8.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 100A, V _{GE} = 15V	-	2.2	2.8	V
Dvnamio	c Characteristics					
C _{ies}	Input Capacitance			6085		pF
C _{oes}	Output Capacitance	V _{CE} = 30V, V _{GE} = 0V, f = 1MHz		725		pF
C _{res}	Reverse Capacitance	1 - 1101112		135		рF
-	Turn-On Delay Time		-	34	-	ns
t _{d(on)}	Turn-On Delay Time	-	-	34	-	ns
t _r	Rise Time Turn-Off Delay Time		_	24 98	-	ns
t _{d(off)}	Fall Time	$V_{CC} = 300 \text{ V}, I_{C} = 100\text{A},$ $R_{G} = 2.4\Omega, V_{GE} = 15\text{V}$		45	-	ns ns
t _f E _{on}	Turn-On Switching Loss	Inductive Load, $T_C = 25^{\circ}C$		0.54	-	mJ
⊏on E _{off}	Turn-Off Switching Loss		_	1.26	_	mJ
E _{ts}	Total Switching Loss		_	1.8	_	mJ
t _{d(on)}	Turn-On Delay Time		-	33	-	ns
t _r	Rise Time		-	28	-	ns
t _{d(off)}	Turn-Off Delay Time		-	101	-	ns
t _f	Fall Time	V_{CC} = 300 V, I_{C} = 100A, R_{G} = 2.4 Ω , V_{GE} = 15V Inductive Load, T_{C} = 125°C	-	171	-	ns
E _{on}	Turn-On Switching Loss		-	1.12	-	mJ
E _{off}	Turn-Off Switching Loss		-	3.18	-	mJ
E _{ts}	Total Switching Loss		-	4.3	-	mJ
	Object Circuit With stead Time	V _{CC} = 300 V, V _{GE} = 15V @ T _C = 100°C	10	-	-	us
T _{sc}	Short Circuit Withstand Time			1	1	us
	Total Gate Charge		-	283	-	
T _{sc} Q _g Q _{ge}		V _{CE} = 300 V, I _C = 100A, V _{GE} = 15V	-	283 50	-	nC nC

$\textbf{Electrical Characteristics of DIODE} \ \, (\textbf{T}_{J} = 25^{\circ}\textbf{C}, \ \, \textbf{Unless Otherwise Specified})$

Symbol	Parameter	Conditions		Min	Тур	Max	Units
V _{FM}	Diode Forward Voltage	I _F = 100A	$T_C = 25^{\circ}C$	-	1.9	2.8	V
			T _C = 100°C	-	1.8	-	
t _{rr}	Diode Reverse Recovery Time	I _F = 100A di / dt = 200 A/us	T _C = 25°C	-	85	125	ns
			T _C = 100°C	-	150	-	
I _{rr}	Diode Peak Reverse Recovery Current		T _C = 25°C	-	8	11	А
			T _C = 100°C	-	13	-	
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C	-	325	635	nC
			T _C = 100°C	-	965	-	

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (IGBT Part, per 1/2 Module)	-	0.25	°C/W
$R_{\theta JC}$	Junction-to-Case (DIODE Part, per 1/2 Module)	-	0.7	°C/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.05	-	°C/W
Weight	Weight of Module	-	90	g

Typical Performance Characteristics

Fig 1. Typical Output Characteristics

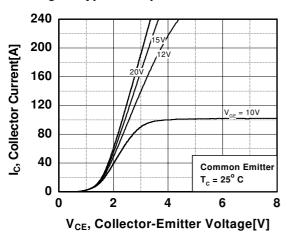


Fig 2. Typical Saturation Voltage Characteristics

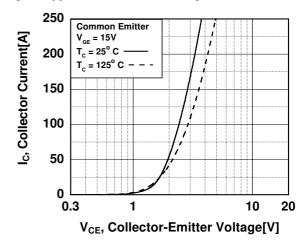


Fig 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

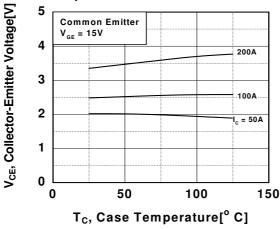


Fig 4. Load Current vs. Frequency

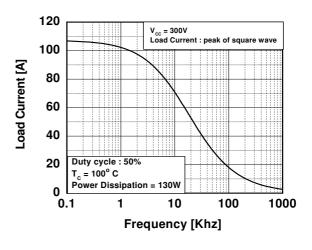


Fig 5. Saturation Voltage vs. V_{GF}

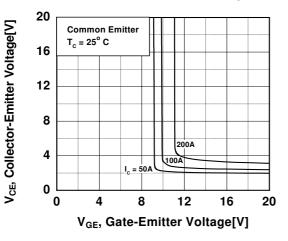
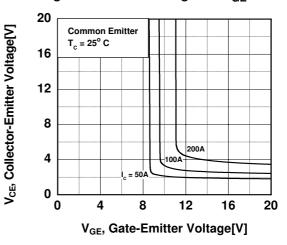


Fig 6. Saturation Voltage vs. V_{GF}





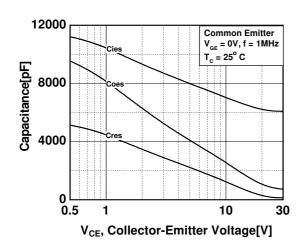


Fig 8. Turn-On Characteristics vs. Gate Resistance

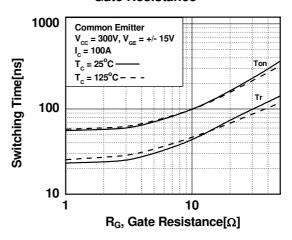


Fig 9. Turn-Off Characteristics vs. Gate Resistance

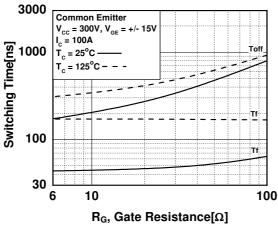


Fig 10. Switching Loss vs. Gate Resistance

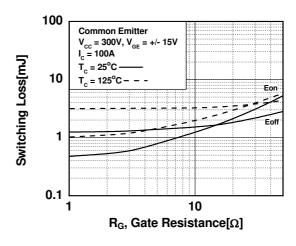


Fig 11. Turn-On Characteristics vs. Collector Current

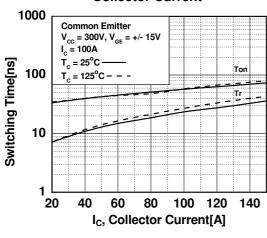
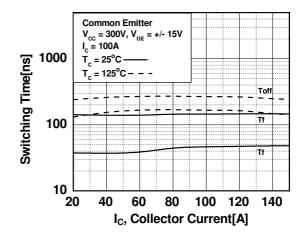


Fig 12. Turn-Off Characteristics vs. Collector Current





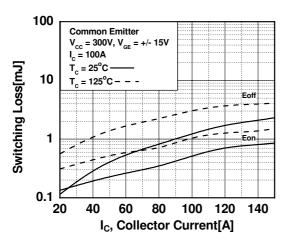


Fig 14. Gate Charge Characteristics

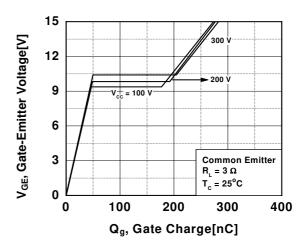


Fig 15. SOA Characteristics

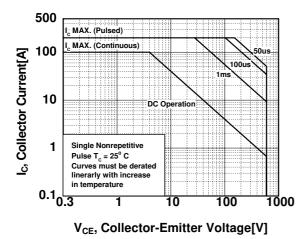


Fig 16. Turn-Off SOA Characteristics

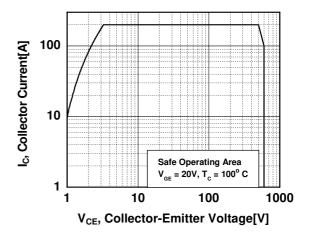


Fig 17. RBSOA Characteristics

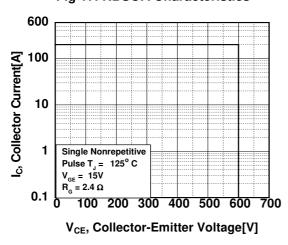


Fig 18. Transient Thermal Impedance

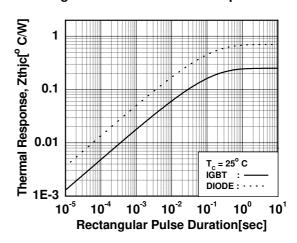


Fig 19. Forward Characteristics

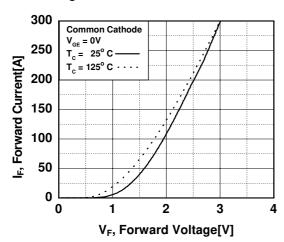
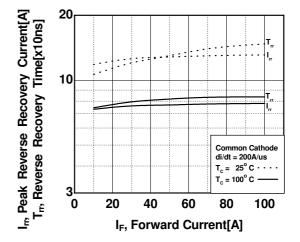
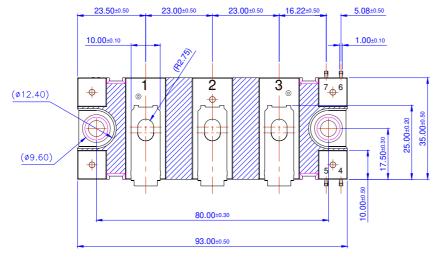
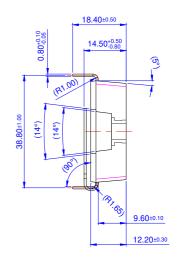


Fig 20. Reverse Recovery Characteristics



Detailed Package Outline Drawings











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Definition of Terms					
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